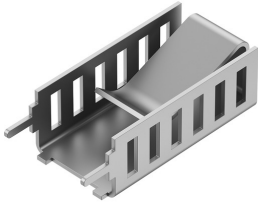


Data sheet Product FK 260



Board Level heatsinks > Attachable heatsink

- universal clip-on heatsinks for design TO 220 and similar
- integrated clamp geometry for a secure fixing of the device
- angled designs with enlarged surface
- modifications and special designs according to customer's specifications

Features

material:	copper (Cu)
for transistor:	<ul style="list-style-type: none"> • TO 220 • TO 248 • SIP-Multiwatt • TO 247 • TO 218
width:	13 mm
height:	9 mm
length:	30 mm
thermal resistance:	23.6 K/W
surface:	solderable surface
version:	with solder lug for vertical installation
material thickness:	0.6 mm

Technical Drawing

23,6 K/W

